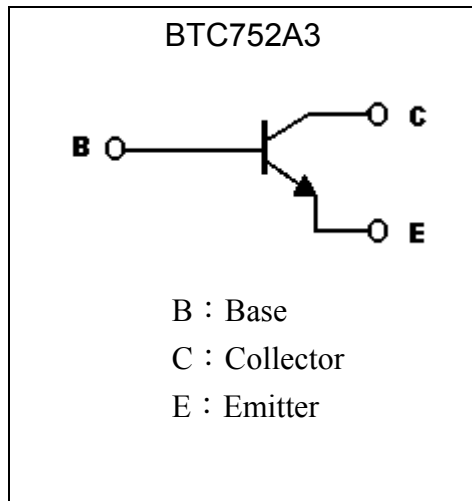
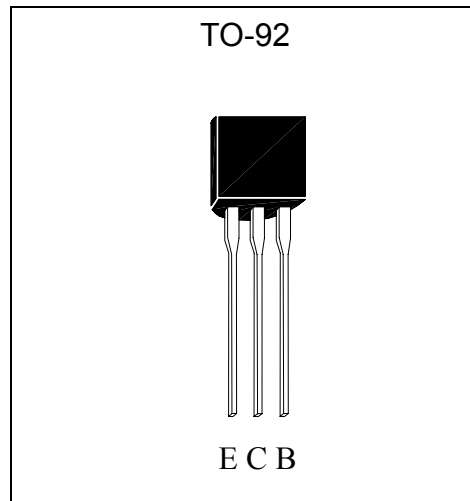


High Frequency NPN Switching Transistor

BTC752A3

Description

- High transition frequency, $f_T=400\text{MHz}(\text{typ})$
- High current, $I_{C(\text{max})}=200\text{mA}$
- Low saturation voltage, $V_{CE(\text{SAT})}=0.3\text{V}(\text{max})$

Symbol

Outline

Absolute Maximum Ratings ($T_a=25^\circ\text{C}$)

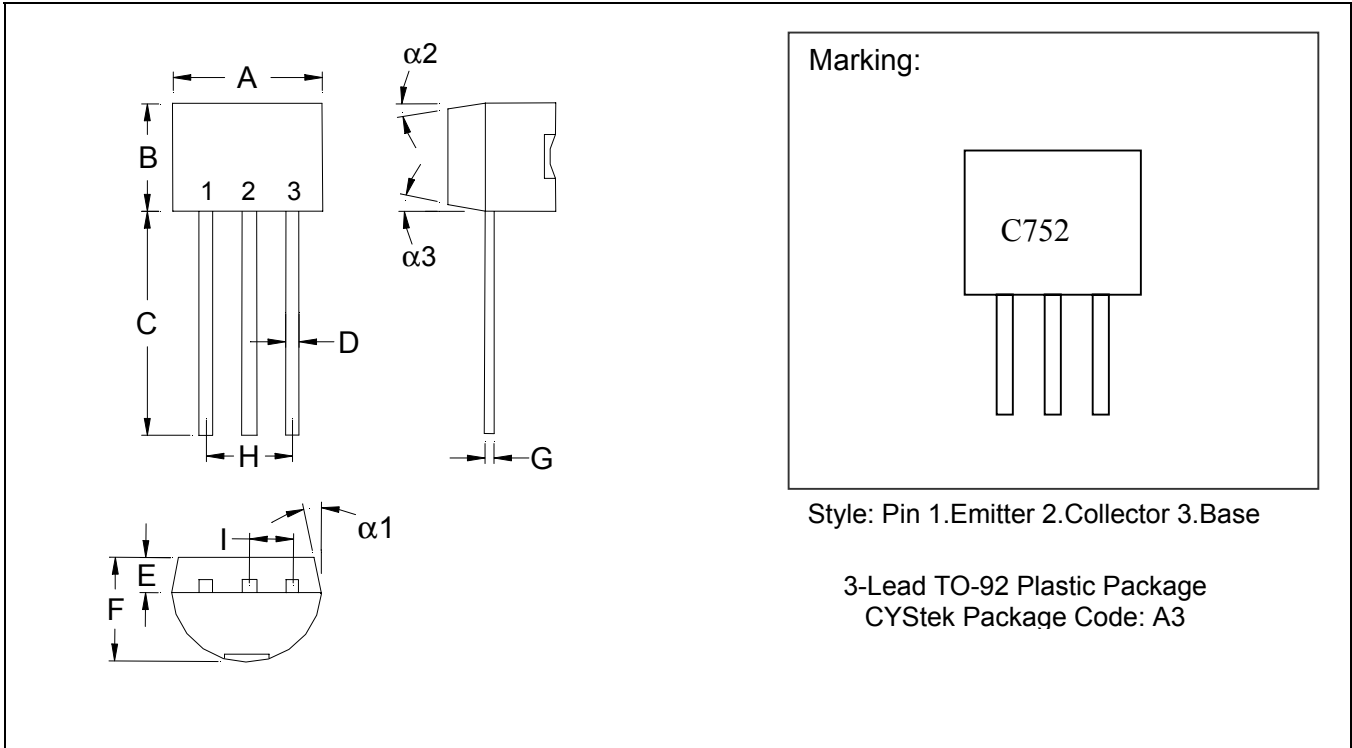
Parameter	Symbol	Limits	Unit
Collector-Base Voltage	V_{CBO}	40	V
Collector-Emitter Voltage	V_{CEO}	15	V
Emitter-Base Voltage	V_{EBO}	4.5	V
Collector Current	I_C	200	mA
Base Current	I_B	40	mA
Power Dissipation	P_d	400	mW
Thermal Resistance, Junction to Ambient	R_{thJA}	250	$^\circ\text{C}/\text{W}$
Junction Temperature	T_j	125	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55~+125	$^\circ\text{C}$

**Characteristics (Ta=25°C)**

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BVCBO	40	-	-	V	IC=50μA
BVCEO	15	-	-	V	IC=1mA
BVEBO	4.5	-	-	V	IE=50μA
ICBO	-	-	100	nA	VCB=40V
IEBO	-	-	100	nA	VEB=4.5V
*VCE(sat) 1	-	-	250	mV	IC=10mA, IB=1mA
*VCE(sat) 2	-	-	300	mV	IC=20mA, IB=1mA
*VBE(sat) 1	700	-	850	mV	IC=10mA, IB=1mA
*VBE(sat) 2	-	-	1	V	IC=20mA, IB=1mA
*hFE1	40	-	120	-	VCE=1V, IC=10mA
*hFE2	20	-	-	-	VCE=2V, IC=100mA
fT	200	400	-	MHz	VCE=10V, IC=10mA, f=100MHz
Cob	-	4	6	pF	VCB=10V, f=1MHz

*Pulse Test: Pulse Width ≤380μs, Duty Cycle≤2%

TO-92 Dimension



*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1704	0.1902	4.33	4.83	G	0.0142	0.0220	0.36	0.56
B	0.1704	0.1902	4.33	4.83	H	-	*0.1000	-	*2.54
C	0.5000	-	12.70	-	I	-	*0.0500	-	*1.27
D	0.0142	0.0220	0.36	0.56	$\alpha 1$	-	*5°	-	*5°
E	-	*0.0500	-	*1.27	$\alpha 2$	-	*2°	-	*2°
F	0.1323	0.1480	3.36	3.76	$\alpha 3$	-	*2°	-	*2°

Notes: 1. Controlling dimension: millimeters.
 2. Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 3. If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: 42 Alloy ; solder plating
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0

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